

ST300C..L SERIES

PHASE CONTROL THYRISTORS

Hockey Puk Version

560A

Features

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AC (B-PUK)

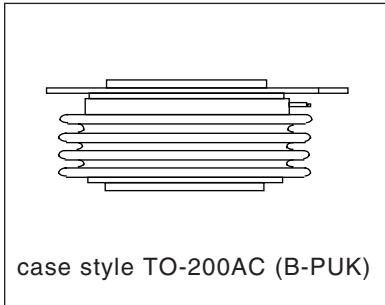
Typical Applications

- DC motor controls
- Controlled DC power supplies
- AC controllers

Major Ratings and Characteristics

Parameters	ST300C..L	Units
$I_{T(AV)}$	560	A
@ T_{hs}	55	°C
$I_{T(RMS)}$	1115	A
@ T_{hs}	25	°C
I_{TSM}	8000	A
@ 60Hz	8380	A
I^2t	320	KA ² s
@ 60Hz	292	KA ² s
V_{DRM}/V_{RRM}	400 to 2000	V
t_q typical	100	μs
T_J	- 40 to 125	°C

case style TO-200AC (B-PUK)



ST300C..L Series

Bulletin I25193 rev. B 04/00

International
IR Rectifier

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , max. repetitive peak and off-state voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_{J \max}$ mA
ST300C..L	04	400	500	50
	08	800	900	
	12	1200	1300	
	16	1600	1700	
	18	1800	1900	
	20	2000	2100	

On-state Conduction

Parameter	ST300C..L	Units	Conditions		
$I_{T(AV)}$	Max. average on-state current @ Heatsink temperature	A	180° conduction, half sine wave double side (single side) cooled		
	560 (275)	55 (75)			
$I_{T(RMS)}$	Max. RMS on-state current	1115	DC @ 25°C heatsink temperature double side cooled		
I_{TSM}	Max. peak, one-cycle non-repetitive surge current	8000	A	t = 10ms	No voltage reapplied
	8380	8380		t = 8.3ms	reapplied
	6730	6730		t = 10ms	100% V_{RRM} reapplied
	7040	7040		t = 8.3ms	Sinusoidal half wave, Initial $T_J = T_{J \max}$.
I^2t	Maximum I^2t for fusing	320	KA ² s	t = 10ms	No voltage reapplied
	292	292		t = 8.3ms	reapplied
	226	226		t = 10ms	100% V_{RRM} reappplied
	207	207		t = 8.3ms	
I^2vt	Maximum I^2vt for fusing	3200	KA ² /s	t = 0.1 to 10ms, no voltage reapplied	
$V_{T(TO)1}$	Low level value of threshold voltage	0.97	V	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_{J \max}$.	
$V_{T(TO)2}$	High level value of threshold voltage	0.98		$(I > \pi \times I_{T(AV)})$, $T_J = T_{J \max}$.	
r_{t1}	Low level value of on-state slope resistance	0.74	mΩ	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_{J \max}$.	
r_{t2}	High level value of on-state slope resistance	0.73		$(I > \pi \times I_{T(AV)})$, $T_J = T_{J \max}$.	
V_{TM}	Max. on-state voltage	2.18	V	$I_{pk} = 1635A$, $T_J = T_{J \max}$, $t_p = 10ms$ sine pulse	
I_H	Maximum holding current	600	mA	$T_J = 25^\circ C$, anode supply 12V resistive load	
I_L	Typical latching current	1000			

Switching

Parameter	ST300C..L	Units	Conditions
di/dt Max. non-repetitive rate of rise of turned-on current	1000	A/μs	Gate drive 20V, 20Ω, $t_r \leq 1\mu s$ $T_J = T_{J_{max}}$, anode voltage ≤ 80% V_{DRM}
t_d Typical delay time	1.0	μs	Gate current 1A, $di_g/dt = 1A/\mu s$ $V_d = 0.67\% V_{DRM}$, $T_J = 25^\circ C$
t_q Typical turn-off time	100		$I_{TM} = 550A$, $T_J = T_{J_{max}}$, $di/dt = 40A/\mu s$, $V_R = 50V$ $dv/dt = 20V/\mu s$, Gate 0V 100Ω, $t_p = 500\mu s$

Blocking

Parameter	ST300C..L	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/μs	$T_J = T_{J_{max}}$, linear to 80% rated V_{DRM}
I_{RRM}/I_{DRM} Max. peak reverse and off-state leakage current	50	mA	$T_J = T_{J_{max}}$, rated V_{DRM}/V_{RRM} applied

Triggering

Parameter	ST300C..L	Units	Conditions
P_{GM} Maximum peak gate power	10.0	W	$T_J = T_{J_{max}}$, $t_p \leq 5ms$
$P_{G(AV)}$ Maximum average gate power	2.0		$T_J = T_{J_{max}}$, $f = 50Hz$, $d\% = 50$
I_{GM} Max. peak positive gate current	3.0	A	$T_J = T_{J_{max}}$, $t_p \leq 5ms$
$+V_{GM}$ Maximum peak positive gate voltage	20	V	$T_J = T_{J_{max}}$, $t_p \leq 5ms$
$-V_{GM}$ Maximum peak negative gate voltage	5.0		
I_{GT} DC gate current required to trigger	TYP.	MAX.	Max. required gate trigger/ current/voltage are the lowest value which will trigger all units 12V anode-to-cathode applied
	200	-	
	100	200	
V_{GT} DC gate voltage required to trigger	50	-	$T_J = -40^\circ C$ $T_J = 25^\circ C$ $T_J = 125^\circ C$
	2.5	-	
	1.8	3.0	
I_{GD} DC gate current not to trigger	1.1	-	Max. gate current/voltage not to trigger is the max. value which will not trigger any unit with rated V_{DRM} anode-to-cathode applied
	10.0	mA	
	0.25	V	

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Thermal and Mechanical Specification

Parameter	ST300C..L	Units	Conditions
T _J	Max. operating temperature range	-40 to 125	°C
T _{stg}	Max. storage temperature range	-40 to 150	
R _{thJ-hs}	Max. thermal resistance, junction to heatsink	0.11 0.05	K/W
R _{thC-hs}	Max. thermal resistance, case to heatsink	0.011 0.006	
F	Mounting force, ± 10%	9800 (1000)	N (Kg)
wt	Approximate weight	250	g
Case style	TO - 200AC (B-PUK)	See Outline Table	

ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.012	0.010	0.008	0.008	K/W	T _J = T _J max.
120°	0.014	0.015	0.014	0.014		
90°	0.018	0.018	0.019	0.019		
60°	0.026	0.027	0.027	0.028		
30°	0.045	0.046	0.046	0.046		

Ordering Information Table

Device Code		ST 30 0 C 20 L 1							
		1	2	3	4	5	6	7	8
1	- Thyristor								
2	- Essential part number								
3	- 0 = Converter grade								
4	- C = Ceramic Puk								
5	- Voltage code: Code x 100 = V _{RRM} (See Voltage Rating Table)								
6	- L = Puk Case TO-200AC (B-PUK)								
7	- 0 = Eyelet terminals (Gate and Auxiliary Cathode Unsoldered Leads) 1 = Fast-on terminals (Gate and Auxiliary Cathode Unsoldered Leads) 2 = Eyelet terminals (Gate and Auxiliary Cathode Soldered Leads) 3 = Fast-on terminals (Gate and Auxiliary Cathode Soldered Leads)								
8	- Critical dv/dt: None = 500V/μsec (Standard value) L = 1000V/μsec (Special selection)								

Outline Table

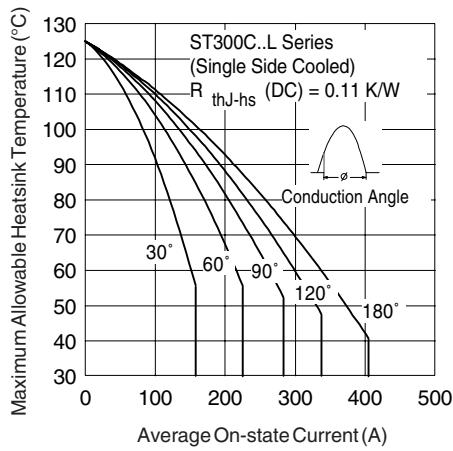
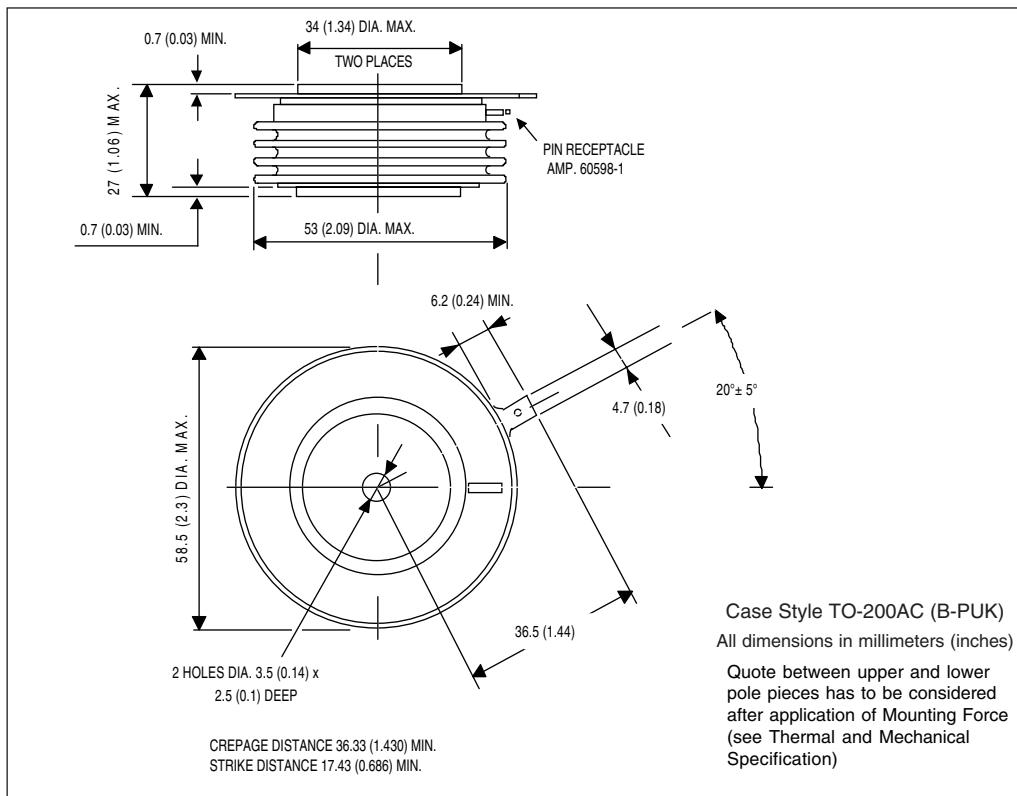


Fig. 1 - Current Ratings Characteristics

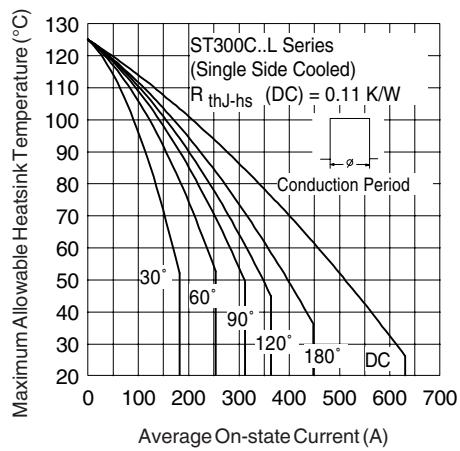


Fig. 2 - Current Ratings Characteristics

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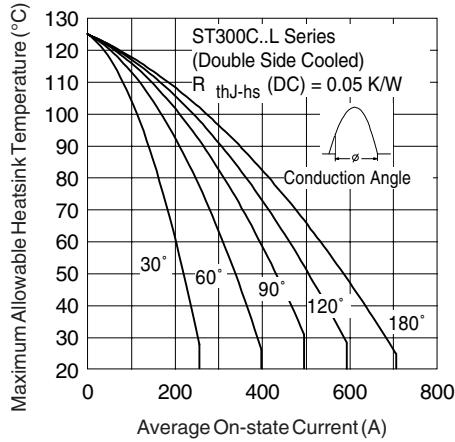


Fig. 3 - Current Ratings Characteristics

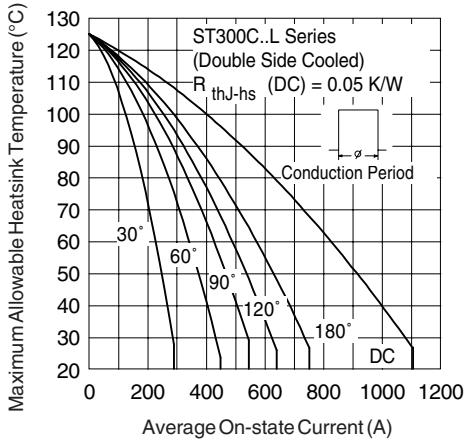


Fig. 4 - Current Ratings Characteristics

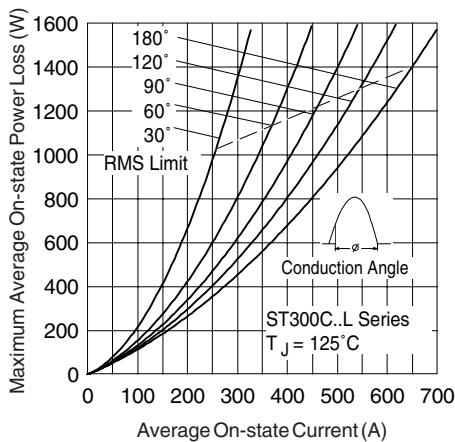


Fig. 5 - On-state Power Loss Characteristics

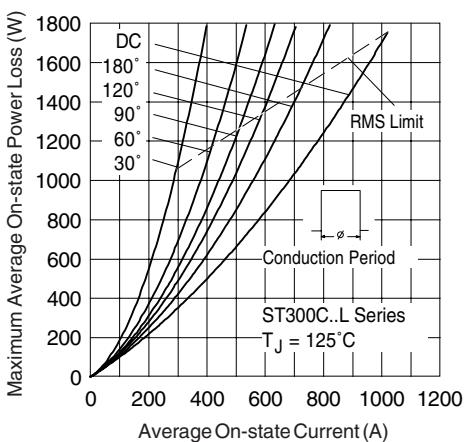


Fig. 6 - On-state Power Loss Characteristics

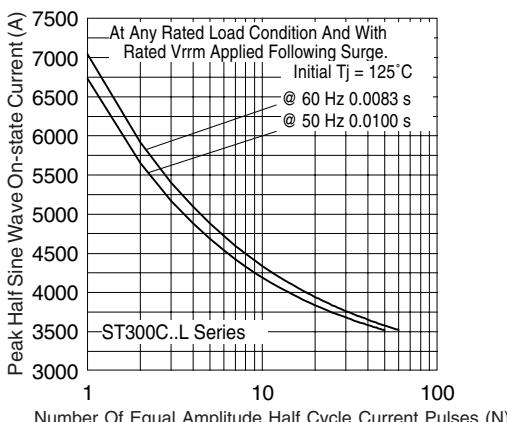


Fig. 7 - Maximum Non-Repetitive Surge Current
Single and Double Side Cooled

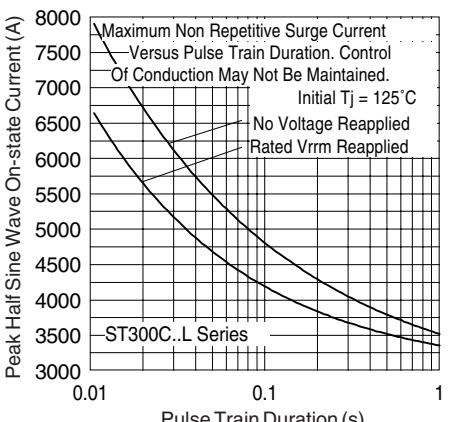


Fig. 8 - Maximum Non-Repetitive Surge Current
Single and Double Side Cooled

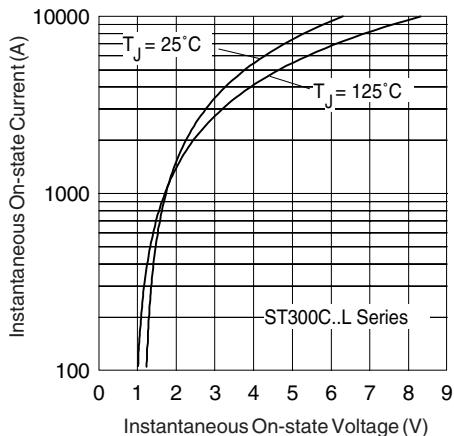


Fig. 9 - On-state Voltage Drop Characteristics

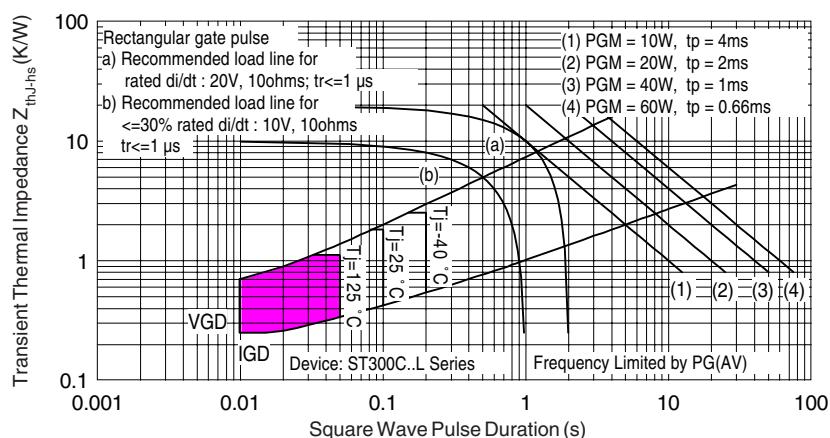


Fig. 10 - Thermal Impedance $Z_{\text{thJ-hs}}$ Characteristics

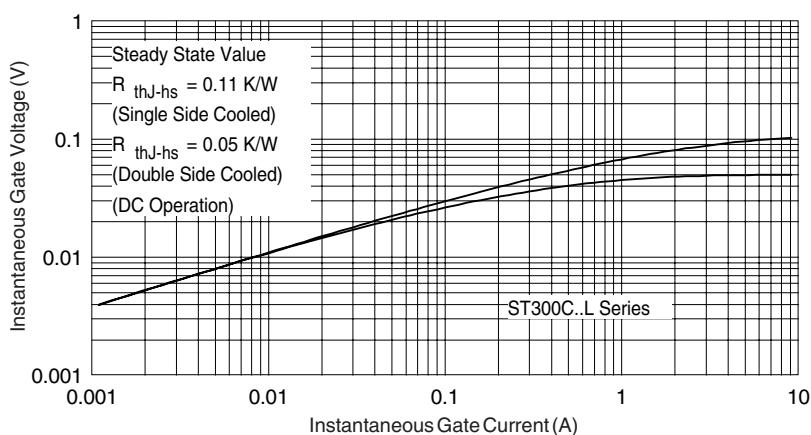


Fig. 11 - Gate Characteristics